19-3955; Rev 4; 4/12

EVALUATION KIT AVAILABLE

# 27-Bit, 2.5MHz-to-42MHz DC-Balanced LVDS Serializer

## **General Description**

The MAX9247 digital video parallel-to-serial converter serializes 27 bits of parallel data into a serial-data stream. Eighteen bits of video data and 9 bits of control data are encoded and multiplexed onto the serial interface, reducing the serial-data rate. The data-enable input determines when the video or control data is serialized.

The MAX9247 pairs with the MAX9248/MAX9250 deserializers to form a complete digital video serial link. Interconnect can be controlled-impedance PCB traces or twisted-pair cable. Proprietary data encoding reduces EMI and provides DC balance. DC balance allows AC-coupling, providing isolation between the transmitting and receiving ends of the interface. The LVDS output is internally terminated with 100 $\Omega$ . For operating frequencies less than 35MHz, the MAX9247 can also pair with the MAX9218 deserializer.

ESD tolerance is specified for ISO 10605 with  $\pm$ 10kV Contact Discharge and  $\pm$ 30kV Air-Gap Discharge.

The MAX9247 operates from a +3.3V core supply and features a separate input supply for interfacing to 1.8V to 3.3V logic levels. This device is available in a 48-lead LQFP package and is specified from -40°C to +85°C or -40°C to +105°C.

## **Applications**

Navigation System Displays In-Vehicle Entertainment Systems Video Cameras LCDs

# Features

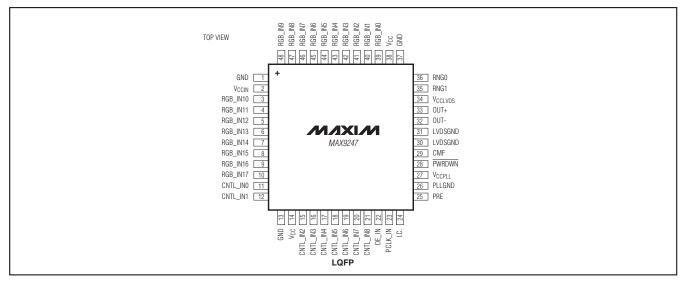
- Preemphasis Improves Eye Diagram and Signal Integrity at the Output
- Proprietary Data Encoding for DC Balance and Reduced EMI
- Control Data Sent During Video Blanking
- Five Control Data Inputs are Single-Bit-Error Tolerant
- Programmable Phase-Shifted LVDS Signaling Reduces EMI
- Output Common-Mode Filter Reduces EMI
- Greater Than 10m STP Cable Drive
- Wide ±2% Reference Clock Tolerance
- ISO 10605 and IEC 61000-4-2 Level 4 ESD Protection
- Separate Input Supply Allows Interface to 1.8V to 3.3V Logic
- ♦ +3.3V Core Supply
- Space-Saving LQFP Package
- ◆ -40°C to +85°C and -40°C to +105°C Operating Temperature Ranges

## Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX9247ECM+	-40°C to +85°C	48 LQFP
MAX9247ECM/V+	-40°C to +85°C	48 LQFP
MAX9247GCM+	-40°C to +105°C	48 LQFP
MAX9247GCM/V+	-40°C to +105°C	48 LQFP

+Denotes a lead(Pb)-free/RoHS-compliant package. /V denotes an automotive qualified part.

## Pin Configuration



## M/X/W

\_ Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

## **ABSOLUTE MAXIMUM RATINGS**

V <sub>CC</sub> to _GND0.5V to +4.0V
Any Ground to Any Ground0.5V to +0.5V
OUT+, OUT-, CMF to LVDSGND0.5V to +4.0V
OUT+, OUT- Short Circuit to LVDSGND
or VCCLVDSContinuous
OUT+, OUT- Short Through 0.125µF (or smaller),
25V Series Capacitor0.5V to +16V
RGB_IN[17:0], CNTL_IN[8:0], DE_IN,
RNG0, RNG1, PRE, PCLK_IN,
PWRDWN to GND0.5V to (VCCIN + 0.5V)
Continuous Power Dissipation ( $T_A = +70^{\circ}C$ )
48-Lead LQFP (derate 20.8mW/°C above +70°C)1666.7mW
ESD Protection

Machine Model ( $R_D = 0\Omega$ ,  $C_S = 200 pF$ )

All Pins to GND±200V
Human Body Model ( $R_D = 1.5 k\Omega$ , $C_S = 100 pF$ )
All Pins to GND±3kV
ISO 10605 (R <sub>D</sub> = $2k\Omega$ , C <sub>S</sub> = 330pF)
Contact Discharge (OUT+, OUT-) to LVDSGND±10kV
Air-Gap Discharge (OUT+, OUT-) to LVDSGND±30kV
IEC 61000-4-2 (R <sub>D</sub> = 330Ω, C <sub>S</sub> = 150pF)
Contact Discharge (OUT+, OUT-) to LVDSGND±10kV
Air-Gap Discharge (OUT+, OUT-) to LVDSGND±15kV
Storage Temperature Range65°C to +150°C
Junction Temperature+150°C
Lead Temperature (soldering, 10s)+300°C
Soldering Temperature (reflow)+260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## DC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = +3.0V \text{ to } +3.6V, R_L = 100\Omega \pm 1\%, \overline{PWRDWN} = \text{high}, PRE = \text{low}, T_A = -40^{\circ}\text{C} \text{ to } +105^{\circ}\text{C}, \text{ unless otherwise noted}.$  Typical values are at  $V_{CC} = +3.3V$ ,  $T_A = +25^{\circ}\text{C}.$ ) (Notes 1, 2)

PARAMETER	SYMBOL	CC	ONDITIONS	MIN	ТҮР	MAX	UNITS
SINGLE-ENDED INPUTS (RGB	_IN[17:0], C	NTL_IN[8:0], DE	IN, PCLK_IN, PWRDWI	N, RNG_, PRE)			
High-Level Input Voltage	VIH	$V_{CCIN} = 1.71V to$	o < 3V (Note 3)	0.65 x V <sub>CCIN</sub>	V	CCIN + 0.3	V
	VIH	$V_{CCIN} = 3.0V$ to	3.6V	2	0.	3 + V <sub>CCIN</sub>	v
Low-Level Input Voltage	VIL	$V_{CCIN} = 1.71V to$	o < 3V (Note 3)	-0.3	0	.3 x V <sub>CCIN</sub>	V
	VIL	$V_{CCIN} = 3.0V$ to	3.6V	-0.3		+0.8	v
Input Current	lın	$V_{CCIN} = 1.71V$ to 3.6V, PWRDWN = high or low		-100		+20	μΑ
		Tight of 10W	$V_{IN} = 0V$ to $(V_{CCIN} + 0.3V)$	) -20		+20	
Input Clamp Voltage	VCL	$I_{CL} = -18 \text{mA}$				-1.5	V
LVDS OUTPUTS (OUT+, OUT-)							
Differential Output Voltage	Vod	Figure 1		250	335	450	mV
Change in V <sub>OD</sub> Between Complementary Output States	$\Delta V_{OD}$	Figure 1				20	mV
Common-Mode Voltage	Vos	Figure 1		1.125	1.29	1.475	V
Change in V <sub>OS</sub> Between Complementary Output States	$\Delta V_{OS}$	Figure 1				20	mV
Output Short-Circuit Current	los	VOUT+ or VOUT-	= 0V or 3.6V	-15	±8	+15	mA
Magnitude of Differential Output Short-Circuit Current	IOSD	$V_{OD} = 0V$		5.5	15	mA	
Output High-Impedance Current	I <sub>OZ</sub>	$\overline{\text{PWRDWN}} = \text{low}$ or V <sub>CC</sub> = 0V	V <sub>OUT+</sub> = 0V, V <sub>OUT-</sub> = 3.6V V <sub>OUT+</sub> = 3.6V V <sub>OUT-</sub> = 0V	1		+1	μΑ

## DC ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC} = +3.0V \text{ to } +3.6V, R_L = 100\Omega \pm 1\%, \overline{PWRDWN} = \text{high}, PRE = \text{low}, T_A = -40^{\circ}\text{C} \text{ to } +105^{\circ}\text{C}, \text{ unless otherwise noted}.$  Typical values are at  $V_{CC} = +3.3V, T_A = +25^{\circ}\text{C}.$  (Notes 1, 2)

PARAMETER	SYMBOL	CONDI	TIONS		MIN	ТҮР	MAX	UNITS
Differential Output Resistance	R <sub>O</sub>				78	110	147	Ω
			2.5MHz	PRE = 0		15	25	
			2.310112	PRE = 1			27	
Worst-Case Supply Current			5MHz	PRE = 0		18	25	
				PRE = 1			27	- mA
	Iccw	$\begin{array}{l} R_{L} = 100\Omega \pm 1\%, \\ C_{L} = 5pF, \\ continuous \ 10 \\ transition \ words \end{array}$	10MHz	PRE = 0		23	28	
				PRE = 1			30	
			20MHz	PRE = 0		33	39	
				PRE = 1			42	
			35MHz	PRE = 0		50	65	
			SOIVINZ	PRE = 1			69	
				PRE = 0		60	70	]
			42MHz	PRE = 1			75	
Power-Down Supply Current	ICCZ	(Note 4)					50	μA

## **AC ELECTRICAL CHARACTERISTICS**

 $(V_{CC_{-}} = +3.0V \text{ to } +3.6V, R_L = 100\Omega \pm 1\%, C_L = 5pF, \overline{PWRDWN} = high, PRE = low, T_A = -40^{\circ}C \text{ to } +105^{\circ}C, unless otherwise noted.$ Typical values are at  $V_{CC_{-}} = +3.3V, T_A = +25^{\circ}C.$ ) (Note 3)

PARAMETER	SYMBOL	CONI	DITIONS	6	MIN	ТҮР	MAX	UNITS
PCLK_IN TIMING REQUIREMENT	ſS							
Cleak Dariad	tт	Figure 0	MAX	9247ECM	23.8		400.0	20
Clock Period	ι	Figure 2	MAX	9247GCM	28.6		400.0	ns
	f	MAX9247ECM			2.5		42.0	
Clock Frequency	fCLK	MAX9247GCM	MAX9247GCM				35.0	MHz
Clock Frequency Difference from Deserializer Reference Clock	Δfclk				-2		+2	%
Clock Duty Cycle	DC	t <sub>HIGH</sub> /t <sub>T</sub> or t <sub>LOW</sub> /t <sub>T</sub>	35	50	65	%		
Clock Transition Time	t <sub>R</sub> , t <sub>F</sub>	Figure 2					2.5	ns
SWITCHING CHARACTERISTICS								
Output Diag Time		20% to 80%,		PRE = low		280	370	
Output Rise Time	<b>t</b> RISE	$V_{OD} \ge 250 mV$ , Fig	ure 3	PRE = high		240 320		ps
Quitaut Fall Time	t	80% to 20%,		PRE = low		280	370	20
Output Fall Time	<sup>t</sup> FALL	V <sub>OD</sub> ≥ 250mV, Figure 3		PRE = high		240	320	ps
Input Setup Time	tSET	Figure 4			3			ns
Input Hold Time	thold	Figure 4			3			ns

## AC ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC_{-}} = +3.0V \text{ to } +3.6V, R_L = 100\Omega \pm 1\%, C_L = 5pF, \overline{PWRDWN} = \text{high}, PRE = \text{low}, T_A = -40^{\circ}\text{C} \text{ to } +105^{\circ}\text{C}, \text{ unless otherwise noted}.$ Typical values are at  $V_{CC_{-}} = +3.3V, T_A = +25^{\circ}\text{C}.)$  (Note 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Serializer Delay	tsd	Figure 5	3.10 x t <sub>T</sub> + 2.0		3.10 x t <sub>T</sub> + 8.0	ns
PLL Lock Time	<sup>t</sup> LOCK	Figure 6			17,100 x t <sub>T</sub>	ns
Power-Down Delay	tPD	Figure 7			1	μs
Peak-to-Peak Output Jitter	ţjitt	Measured with PRBS input pattern at 840Mbps data rate			150	ps
Peak-to-Peak Output Offset	Maria	840Mbps data rate, CMF open, Figure 8		22	70	
Voltage	VOS(P-P)	840Mbps data rate, CMF 0.1µF to ground, Figure 8	12		50	mV

Note 1: Current into a pin is defined as positive. Current out of a pin is defined as negative. All voltages are referenced to ground, except VOD,  $\Delta$ VOD, and  $\Delta$ VOS.

Note 2: Maximum and minimum limits over temperature are guaranteed by design and characterization. Devices are production tested at  $T_A = +25^{\circ}C$ .

Note 3: Parameters are guaranteed by design and characterization and are not production tested. Limits are set at ±6 sigma.

**Note 4:** All LVTTL/LVCMOS inputs, except  $\overline{PWRDWN}$  at  $\leq 0.3V$  or  $\geq V_{CCIN} - 0.3V$ .  $\overline{PWRDWN}$  is  $\leq 0.3V$ .

1.00E-10

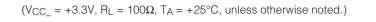
 CAT5 CABLE LENGTH (m)

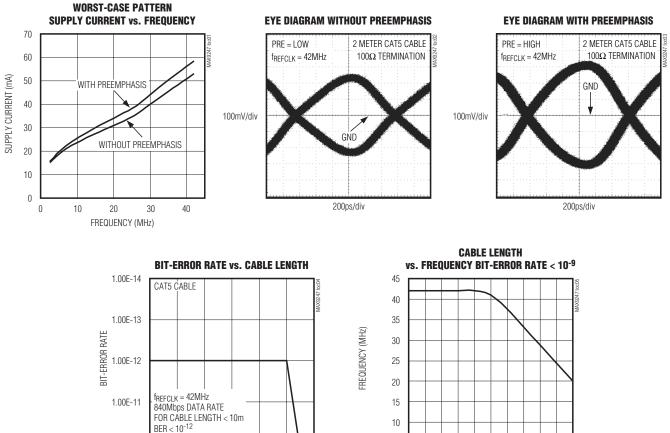
# 27-Bit, 2.5MHz-to-42MHz DC-Balanced LVDS Serializer

## **Typical Operating Characteristics**

6 8 10 12 14 16 18 20

CABLE LENGTH (m)



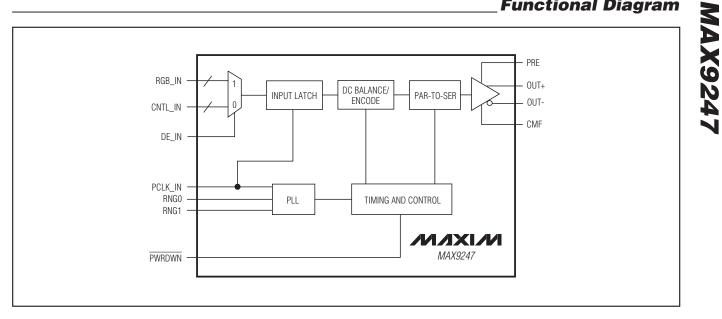


**MAX9247** 

## \_Pin Description

PIN	NAME	FUNCTION
1, 13, 37	GND	Input Buffer Supply and Digital Supply Ground
2	VCCIN	Input Buffer Supply Voltage. Bypass to GND with 0.1µF and 0.001µF capacitors in parallel as close to the device as possible, with the smallest value capacitor closest to the supply pin.
3–10, 39–48	RGB_IN10- RGB_IN17, RGB_IN0- RGB_IN9	LVTTL/LVCMOS Red, Green, and Blue Digital Video Data Inputs. Eighteen data bits are loaded into the input latch on the rising edge of PCLK_IN when DE_IN is high. Internally pulled down to GND.
11, 12, 15–21	CNTL_IN0, CNTL_IN1, CNTL_IN2– CNTL_IN8	LVTTL/LVCMOS Control Data Inputs. Control data are latched on the rising edge of PCLK_IN when DE_IN is low. Internally pulled down to GND.
14, 38	V <sub>CC</sub>	Digital Supply Voltage. Bypass to GND with $0.1\mu$ F and $0.001\mu$ F capacitors in parallel as close to the device as possible, with the smallest value capacitor closest to the supply pin.
22	DE_IN	LVTTL/LVCMOS Data-Enable Input. Logic-high selects RGB_IN[17:0] to be latched. Logic-low selects CNTL_IN[8:0] to be latched. DE_IN must be switching for proper operation. Internally pulled down to GND.
23	PCLK_IN	LVTTL/LVCMOS Parallel Clock Input. Latches data and control inputs and provides the PLL reference clock. Internally pulled down to GND.
24	I.C.	Internally Connected. Leave unconnected for normal operation.
25	PRE	Preemphasis Enable Input. Drive PRE high to enable preemphasis.
26	PLLGND	PLL Supply Ground
27	VCCPLL	PLL Supply Voltage. Bypass to PLLGND with 0.1µF and 0.001µF capacitors in parallel as close to the device as possible, with the smallest value capacitor closest to the supply pin.
28	PWRDWN	LVTTL/LVCMOS Power-Down Input. Internally pulled down to GND.
29	CMF	Common-Mode Filter. Optionally connect a capacitor between CMF and LVDSGND to filter common-mode switching noise.
30, 31	LVDSGND	LVDS Supply Ground
32	OUT-	Inverting LVDS Serial-Data Output
33	OUT+	Noninverting LVDS Serial-Data Output
34	VCCLVDS	LVDS Supply Voltage. Bypass to LVDSGND with 0.1µF and 0.001µF capacitors in parallel as close to the device as possible, with the smallest value capacitor closest to the supply pin.
35	RNG1	LVTTL/LVCMOS Frequency Range Select Input. Set to the frequency range that includes the PCLK_IN frequency as shown in Table 3. Internally pulled down to GND.
36	RNG0	LVTTL/LVCMOS Frequency Range Select Input. Set to the frequency range that includes the PCLK_IN frequency as shown in Table 3. Internally pulled down to GND.

## **Functional Diagram**



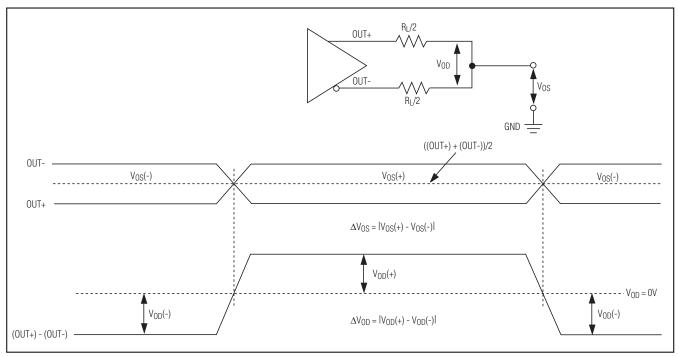


Figure 1. LVDS DC Output Load and Parameters

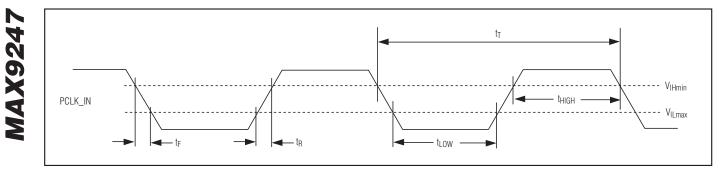
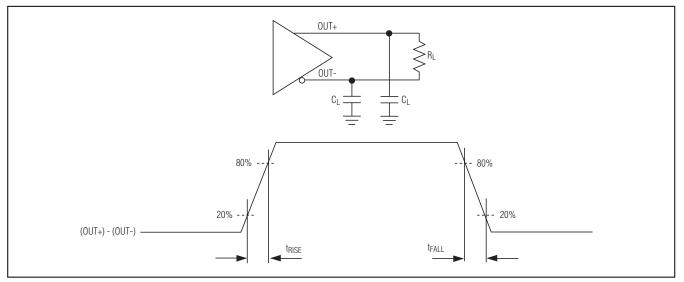


Figure 2. Parallel Clock Requirements





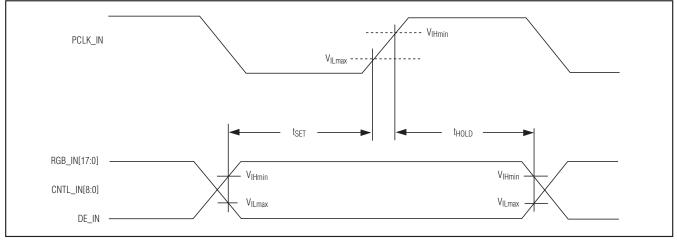


Figure 4. Synchronous Input Timing

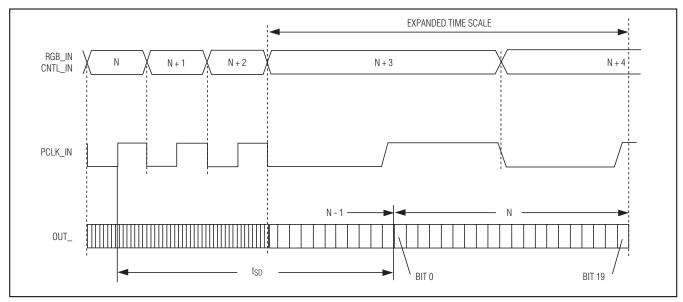


Figure 5. Serializer Delay

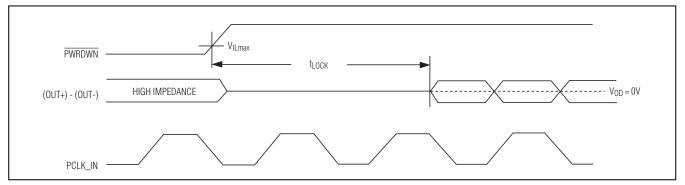


Figure 6. PLL Lock Time

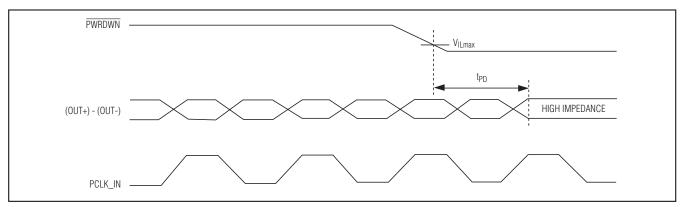


Figure 7. Power-Down Delay

9

**MAX9247** 

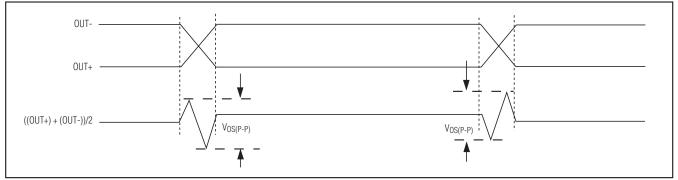


Figure 8. Peak-to-Peak Output Offset Voltage

## **Detailed Description**

The MAX9247 DC-balanced serializer operates at a 2.5MHz-to-42MHz parallel clock frequency, serializing 18 bits of parallel video data RGB\_IN[17:0] when the data-enable input DE\_IN is high, or 9 bits of parallel control data CNTL\_IN[8:0] when DE\_IN is low. The RGB video input data are encoded using 2 overhead bits, EN0 and EN1, resulting in a serial word length of 20 bits (see Table 1). Control inputs are mapped to 19 bits and encoded with 1 overhead bit, EN0, also resulting in a 20-bit serial word. Encoding reduces EMI and

maintains DC balance across the serial cable. Two transition words, which contain a unique bit sequence, are inserted at the transition boundaries of video-tocontrol and control-to-video phases.

Control data inputs C0 to C4 are mapped to 3 bits each in the serial control word (see Table 2). At the deserializer, 2 or 3 bits at the same state determine the state of the recovered bit, providing single-bit-error tolerance for C0 to C4. Control data that may be visible if an error occurs, such as VSYNC and HSYNC, can be connected to these inputs. Control data inputs C5 to C8 are mapped to 1 bit each.

#### Table 1. Serial Video Phase Word Format

0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19
EN0	EN1	S0	S1	S2	S3	S4	S5	S6	S7	S8	S9	S10	S11	S12	S13	S14	S15	S16	S17

Bit 0 is the LSB and is serialized first. EN[1:0] are encoding bits. S[17:0] are encoded symbols.

#### Table 2. Serial Control Phase Word Format

0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19
EN0	C0	C0	C0	C1	C1	C1	C2	C2	C2	C3	C3	C3	C4	C4	C4	C5	C6	C7	C8

Bit 0 is the LSB and is serialized first. C[8:0] are the control inputs.

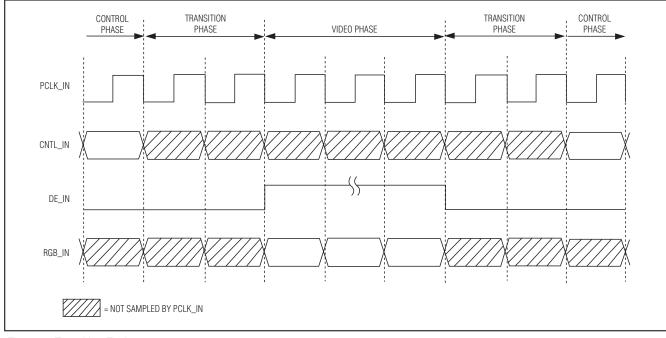


Figure 9. Transition Timing

#### **Transition Timing**

The transition words require interconnect bandwidth and displace control data. Therefore, control data is not sampled (see Figure 9):

- Two clock cycles before DE\_IN goes high
- During the video phase
- Two clock cycles after DE\_IN goes low

The last sampled control data are latched at the deserializer control data outputs during the transition and video phases. Video data are latched at the deserializer RGB data outputs during the transition and control phases.

## Applications Information

#### **AC-Coupling Benefits**

AC-coupling increases the common-mode voltage to the voltage rating of the capacitor. Two capacitors are sufficient for isolation, but four capacitors—two at the serializer output and two at the deserializer input—provide protection if either end of the cable is shorted to a high voltage. AC-coupling blocks low-frequency ground shifts and common-mode noise. The MAX9247 serializer can also be DC-coupled to the MAX9248/ MAX9250 deserializers.

Figures 10 and 12 show an AC-coupled serializer and deserializer with two capacitors per link. Figures 11 and

13 show the AC-coupled serializer and deserializer with four capacitors per link.

#### **Selection of AC-Coupling Capacitors**

See Figure 14 for calculating the capacitor values for AC-coupling depending on the parallel clock frequency. The plot shows capacitor values for two- and four-capacitor-per-link systems. For applications using less than 18MHz clock frequency, use 0.1µF capacitors.

#### Frequency-Range Setting RNG[1:0]

The RNG[1:0] inputs select the operating frequency range of the MAX9247 serializer. An external clock within this range is required for operation. Table 3 shows the selectable frequency ranges and corresponding data rates for the MAX9247.

# Table 3. Parallel Clock Frequency RangeSelect

RNG1	RNG0	PARALLEL CLOCK (MHz)	SERIAL-DATA RATE (Mbps)
0	0	2.5 to 5	50 to 100
0	1	5 to10	100 to 200
1	0	10 to 20	200 to 400
1	1	20 to 42	400 to 840



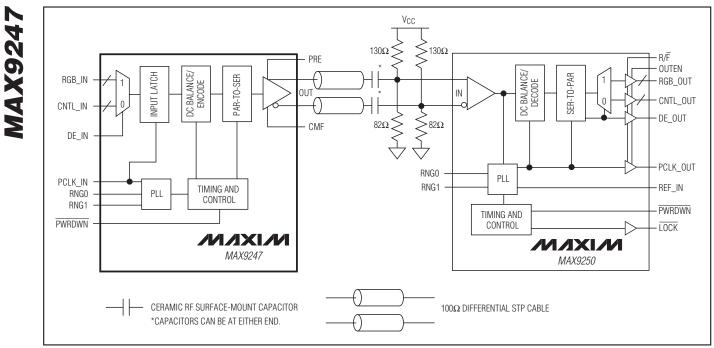


Figure 10. AC-Coupled MAX9247 Serializer and MAX9250 Deserializer with Two Capacitors per Link

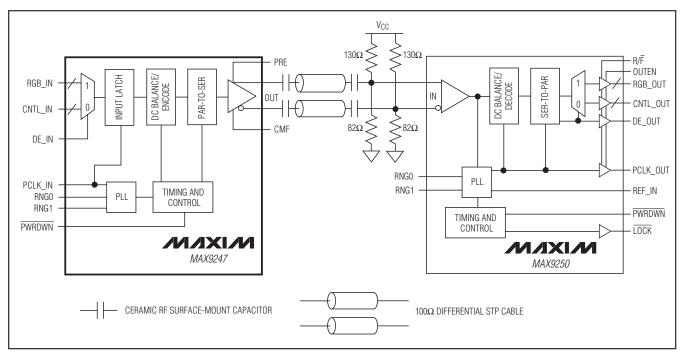


Figure 11. AC-Coupled MAX9247 Serializer and MAX9250 Deserializer with Four Capacitors per Link

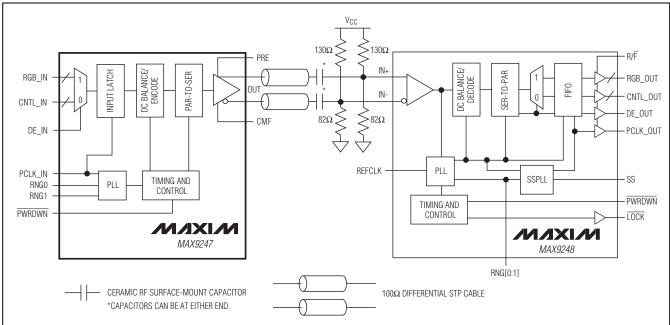


Figure 12. AC-Coupled MAX9247 Serializer and MAX9248 Deserializer with Two Capacitors per Link

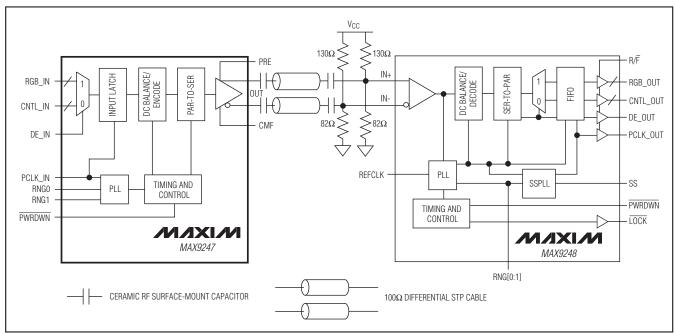


Figure 13. AC-Coupled MAX9247 Serializer and MAX9248 Deserializer with Four Capacitors per Link

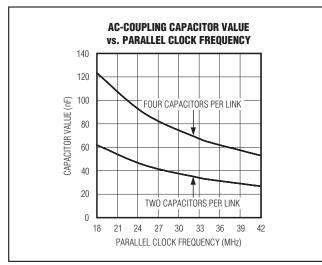


Figure 14. AC-Coupling Capacitor Values vs. Clock Frequency of 18MHz to 42MHz

**Termination** The MAX9247 has an integrated  $100\Omega$  output-termination resistor. This resistor damps reflections from induced noise and mismatches between the transmission line impedance and termination resistors at the deserializer input. With PWRDWN = low or with the supply off, the output termination is switched out and the LVDS output is high impedance.

#### **Common-Mode Filter**

The integrated 100 $\Omega$  output termination is made up of two 50 $\Omega$  resistors in series. The junction of the resistors is connected to the CMF pin for connecting an optional common-mode filter capacitor. Connect the filter capacitor to ground close to the MAX9247 as shown in Figure 15. The capacitor shunts common-mode switching current to ground to reduce EMI.

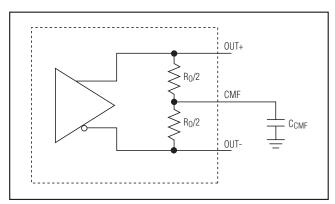


Figure 15. Common-Mode Filter Capacitor Connection

#### **LVDS Output Preemphasis (PRE)**

The MAX9247 features a preemphasis mode where extra current is added to the output and causes the amplitude to increase by 40% to 50% at the transition point. Preemphasis helps to get a faster transition, better eye diagram, and improve signal integrity. See the *Typical Operating Characteristics*. The additional current is turned on for a short time (360ps, typ) during data transition, and then turned off. Enable preemphasis by driving PRE high.

#### **Power-Down and Power-Off**

Driving  $\overline{\text{PWRDWN}}$  low stops the PLL, switches out the integrated 100 $\Omega$  output termination, and puts the output in high impedance to ground and differential. With  $\overline{\text{PWRD-WN}} \leq 0.3V$  and all LVTTL/LVCMOS inputs  $\leq 0.3V$  or  $\geq$  VCCIN - 0.3V, supply current is reduced to 50µA or less. Driving  $\overline{\text{PWRDWN}}$  high starts PLL lock to PCLK\_IN and

switches in the 100 $\Omega$  output termination resistor. The LVDS output is not driven until the PLL locks. The LVDS output is high impedance to ground and 100 $\Omega$  differential. The 100 $\Omega$  integrated termination pulls OUT+ and OUT- together while the PLL is locking so that V<sub>OD</sub> = 0V.

If  $V_{CC} = 0$ , the output resistor is switched out and the LVDS outputs are high impedance to ground and differential.

#### **PLL Lock Time**

The PLL lock time is set by an internal counter. The lock time is 17,100 PCLK\_IN cycles. Power and clock should be stable to meet the lock-time specification.

#### **Input Buffer Supply**

The single-ended inputs (RGB\_IN[17:0], CNTL\_IN[8:0], DE\_IN, RNG0, RNG1, PRE, PCLK\_IN, and PWRDWN) are powered from V<sub>CCIN</sub>. V<sub>CCIN</sub> can be connected to a 1.71V to 3.6V supply, allowing logic inputs with a nominal swing of V<sub>CCIN</sub>. If no power is applied to V<sub>CCIN</sub> when power is applied to V<sub>CC</sub>, the inputs are disabled and PWRDWN is internally driven low, putting the device in the power-down state.

#### Power-Supply Sequencing of MAX9247 and MAX9248/MAX9250 Video Link

The MAX9247 and MAX9248/MAX9250 video link can be powered up in several ways. The best approach is to keep both MAX9247 and MAX9248 powered down while supplies are ramping up and PCLK\_IN of the MAX9247 and REFCLK of the MAX9248/MAX9250 are stabilizing. After all of the power supplies of the MAX9247 and MAX9248/MAX9250 are stable, including PCLK\_IN and REFCLK, do the following:

1) Power up the MAX9247 first



**MAX9247** 

- 2) Wait for at least  $t_{LOCK}$  of MAX9247 (or 17100 x  $t_T$ ) to get activity on the link
- 3) Power up the MAX9248

#### **Power-Supply Circuits and Bypassing**

The MAX9247 has isolated on-chip power domains. The digital core supply (V<sub>CC</sub>) and single-ended input supply (V<sub>CCIN</sub>) are isolated but have a common ground (GND). The PLL has separate power and ground (V<sub>CCPLL</sub> and PLLGND) and the LVDS input also has separate power and ground (V<sub>CCLVDS</sub> and LVDSGND). The grounds are isolated by diode connections. Bypass each V<sub>CC</sub>, V<sub>CCIN</sub>, V<sub>CCPLL</sub>, and V<sub>CCLVDS</sub> pin with high-frequency, surface-mount ceramic 0.1µF and 0.001µF capacitors in parallel as close to the device as possible, with the smallest value capacitor closest to the supply pin.

**LVDS Output** The LVDS output is a current source. The voltage swing is proportional to the termination resistance. The output is rated for a differential load of  $100\Omega \pm 1\%$ .

#### **Cables and Connectors**

Interconnect for LVDS typically has a differential impedance of  $100\Omega$ . Use cables and connectors that have matched differential impedance to minimize impedance discontinuities.

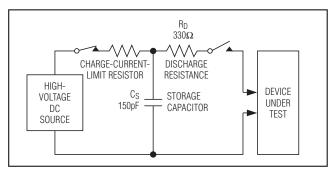


Figure 16. IEC 61000-4-2 Contact Discharge ESD Test Circuit

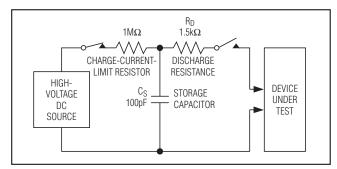


Figure 17. Human Body ESD Test Circuit

Twisted-pair and shielded twisted-pair cables offer superior signal quality compared to ribbon cable and tend to generate less EMI due to magnetic field canceling effects. Balanced cables pick up noise as common mode, which is rejected by the LVDS receiver.

#### **Board Layout**

Separate the LVTTL/LVCMOS inputs and LVDS output to prevent crosstalk. A four-layer PCB with separate layers for power, ground, and signals is recommended.

#### **ESD** Protection

The MAX9247 ESD tolerance is rated for IEC 61000-4-2, Human Body Model, Machine Model, and ISO 10605 standards. IEC 61000-4-2 and ISO 10605 specify ESD tolerance for electronic systems. The IEC 61000-4-2 discharge components are  $C_S = 150pF$  and  $R_D =$  $330\Omega$  (Figure 16). For IEC 61000-4-2, the LVDS outputs are rated for ±8kV Contact Discharge and ±15kV Air-Gap Discharge. The Human Body Model discharge components are Cs = 100pF and RD =  $1.5k\Omega$  (Figure 17). For the Human Body Model, all pins are rated for ±3kV Contact Discharge. The ISO 10605 discharge components are Cs = 330pF and RD =  $2k\Omega$  (Figure 18). For ISO 10605, the LVDS outputs are rated for ±10kV contact and ±30kV air discharge. The Machine Model discharge components are  $C_S = 200 pF$  and  $R_D = 0\Omega$  (Figure 19).

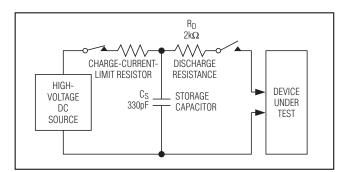


Figure 18. ISO 10605 Contact Discharge ESD Test Circuit

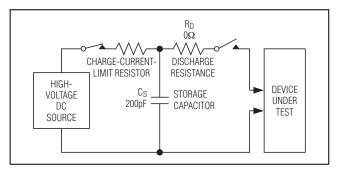


Figure 19. Machine Model ESD Test Circuit



### **Chip Information**

#### PROCESS: CMOS

## **Package Information**

For the latest package outline information and land patterns (footprints), go to <u>www.maxim-ic.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE	PACKAGE	OUTLINE NO.	LAND
TYPE	CODE		PATTERN NO.
48 LQFP	C48+5	<u>21-0054</u>	<u>90-0093</u>